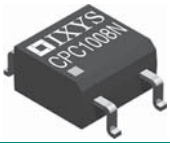
IXYS
INTEGRATED CIRCUITS DIVISION



CPC1008N
Single-Pole, Normally Open 4-Pin SOP OptoMOS® Relay

Parameter	Rating	Units
Blocking Voltage	100	V_P
Load Current	150	mA_{rms} / mA_{DC}
On-Resistance (max)	8	Ω

Features
- $1500V_{rms}$ Input/Output Isolation
- Small 4-Pin SOP Package
- Low Drive Power Requirements
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Wave Solderable
- Tape & Reel Version Available

Applications
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security Systems
- Aerospace
- Industrial Controls
- Reed Relay Replacement

Description
CPC1008N is a miniature, low-voltage, low on-resistance, single-pole, normally open (1-Form-A) solid state relay in a 4-Pin SOP package. It uses IXYS Integrated Circuits Division's patented, optically coupled, OptoMOS architecture to provide 1500Vrms of input/output isolation.

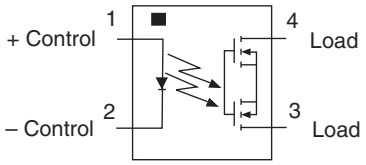
Using IXYS Integrated Circuits Division's state of the art double-molded vertical construction packaging, the CPC1008N is one of the world's smallest relays. It is ideal for replacing larger, less-reliable reed and electromechanical relays.

Approvals
- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component: Certificate B 13 12 82667 003

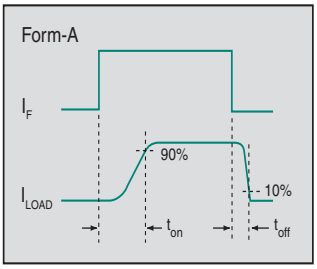
Ordering Information

Part #	Description
CPC1008N	4-Pin SOP (100/tube)
CPC1008NTR	4-Pin SOP (2000/reel)

Pin Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25ºC

Parameter	Ratings	Units
Blocking Voltage	100	V_P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation	70	mW
Total Power Dissipation [1]	400	mW
Isolation Voltage, Input to Output (60 Seconds)	1500	V_{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

[1] Derate linearly 3.33 mW / ºC

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

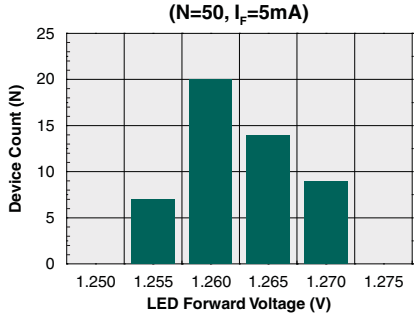
Electrical Characteristics @ 25ºC

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Continuous [1]	-	I_L			150	mA_{rms} / mA_{DC}
Peak	t=10ms	I_{LPK}	-	-	±350	mA_P
On-Resistance [2]	I_L=150mA	R_{ON}	-	4.8	8	Ω
Off-State Leakage Current	V_L=100V_P	I_{LEAK}	-	-	1	µA
Switching Speeds						
Turn-On	I_F=5mA, V_L=10V	t_{on}	-	1	2	ms
Turn-Off		t_{off}	-	0.17	1	
Output Capacitance	I_F=0mA, V_L=50V, f=1MHz	C_{OUT}	-	6	-	pF
Input Characteristics						
Input Control Current to Activate [3]	I_L=150mA	I_F	-	0.45	2	mA
Input Control Current to Deactivate	-	I_F	0.2	-	-	mA
Input Voltage Drop	I_F=5mA	V_F	0.9	1.2	1.4	V
Reverse Input Current	V_R=5V	I_R	-	-	10	µA
Common Characteristics						
Capacitance, Input to Output	-	$C_{I/O}$	-	1	-	pF

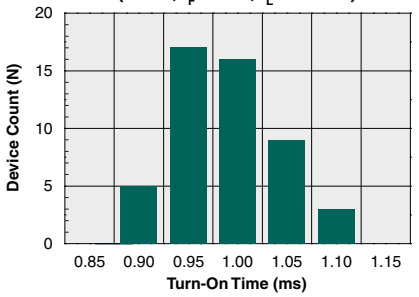
[1] Load current derates linearly from 150mA @ 25ºC to 120mA @ 85ºC.
[2] Measurement taken within 1 second of on time.
[3] For high temperature operation (>60ºC) a minimum LED drive current of 4mA is recommended.

PERFORMANCE DATA (@ 25°C Unless Otherwise Specified)*

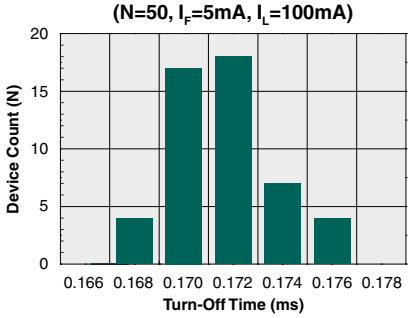
Typical LED Forward Voltage Drop (N=50, I_F=5mA)



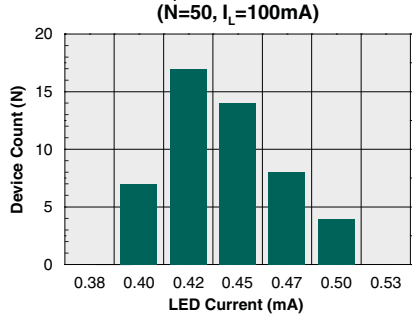
Typical Turn-On Time (N=50, I_F=5mA, I_L=100mA)



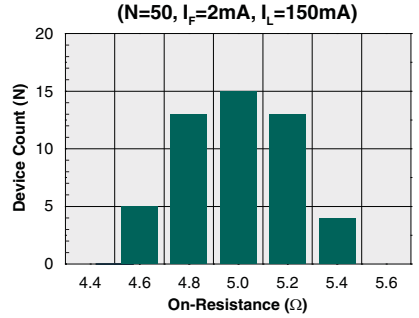
Typical Turn-Off Time (N=50, I_F=5mA, I_L=100mA)



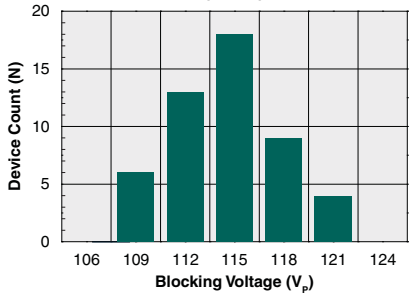
Typical I_F for Switch Operation (N=50, I_L=100mA)



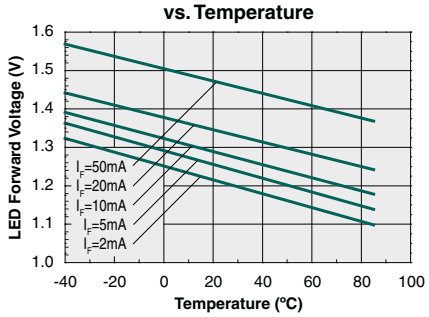
Typical On-Resistance Distribution (N=50, I_F=2mA, I_L=150mA)



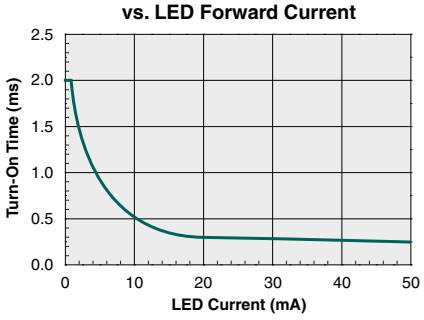
Typical Blocking Voltage Distribution (N=50)



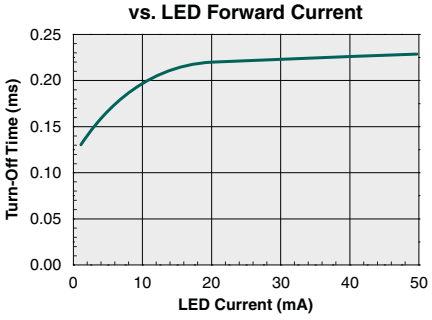
Typical LED Forward Voltage Drop vs. Temperature



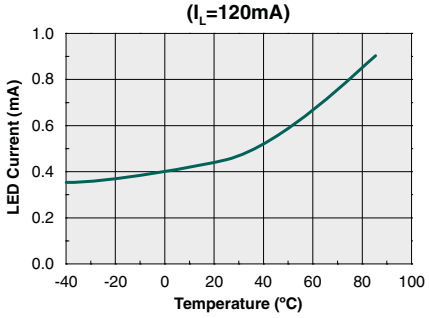
Typical Turn-On Time vs. LED Forward Current



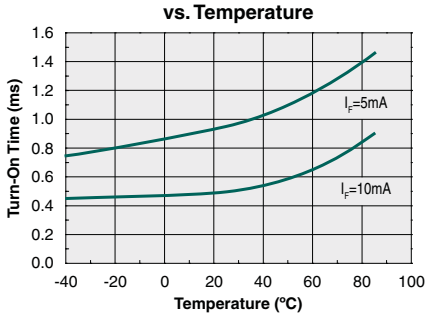
Typical Turn-Off Time vs. LED Forward Current



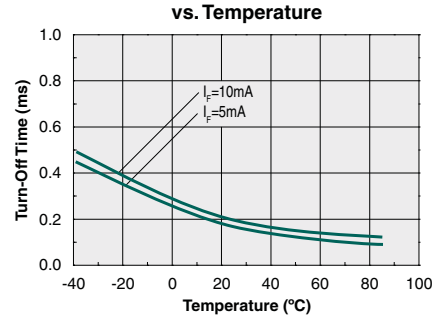
Typical I_F for Switch Operation vs. Temperature (I_L=120mA)



Typical Turn-On Time vs. Temperature



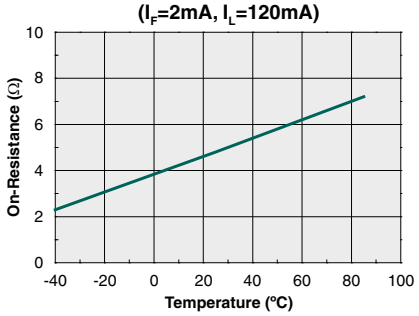
Typical Turn-Off Time vs. Temperature



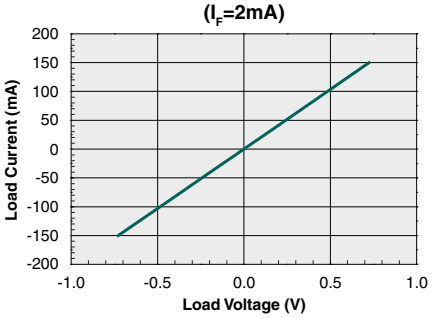
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA (@ 25°C Unless Otherwise Specified)*

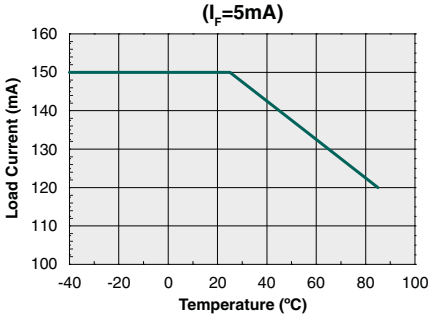
Typical On-Resistance vs. Temperature (I_F=2mA, I_L=120mA)



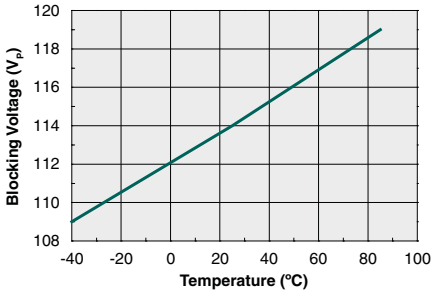
Typical Load Current vs. Load Voltage (I_F=2mA)



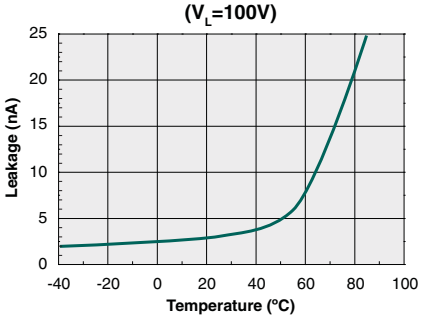
Maximum Load Current vs. Temperature (I_F=5mA)



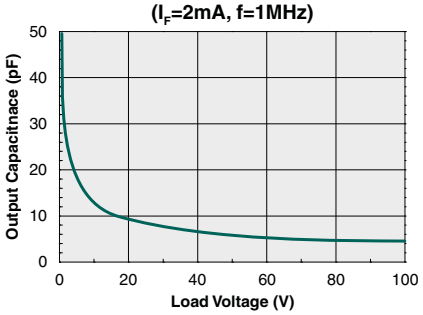
Typical Blocking Voltage vs. Temperature



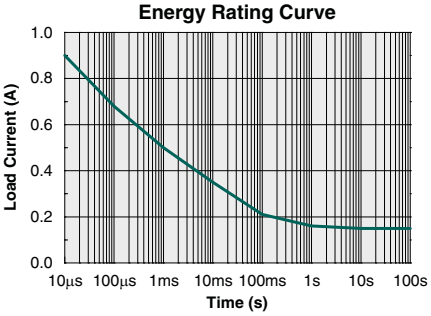
Typical Leakage vs. Temperature (V_L=100V)



Output Capacitance vs. Load Voltage (I_F=2mA, f=1MHz)



Energy Rating Curve



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1008N	MSL 3

ESD Sensitivity

This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

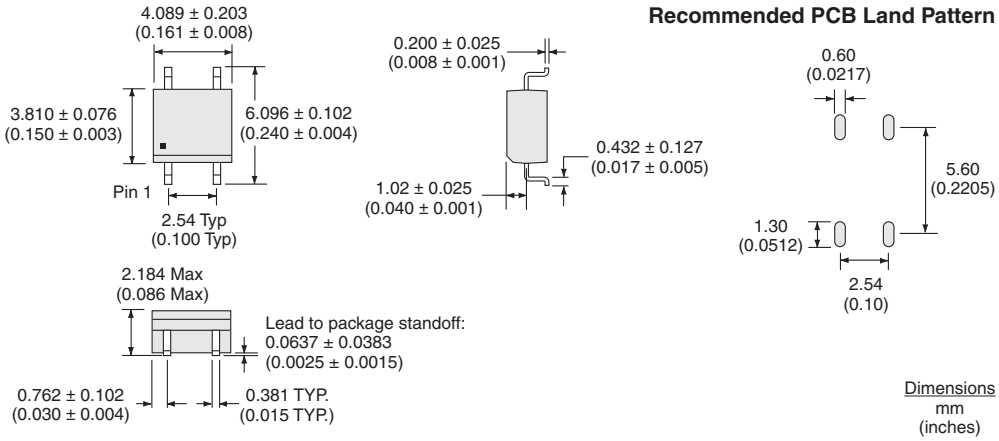
Device	Maximum Temperature x Time
CPC1008N	260°C for 30 seconds

Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

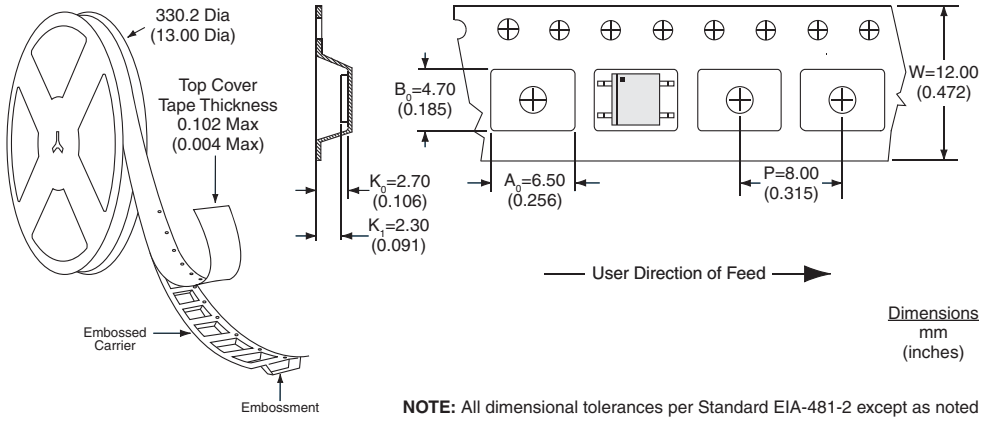
MECHANICAL DIMENSIONS

CPC1008N



Dimensions
mm
(inches)

CPC1008NTR Tape & Reel



Dimensions
mm
(inches)

NOTE: All dimensional tolerances per Standard EIA-481-2 except as noted

For additional information please visit our website at: www.ixysic.com

Specification: DS-CPC1008N-R10

8/18/2014